

EDCON-COMPONENTS

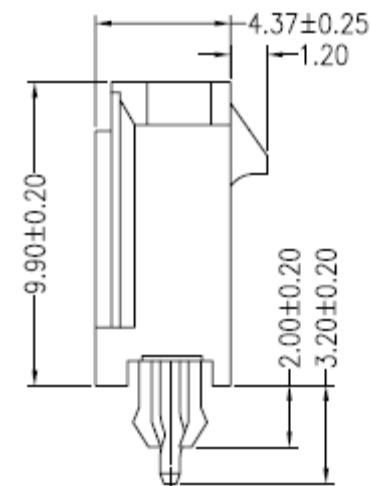
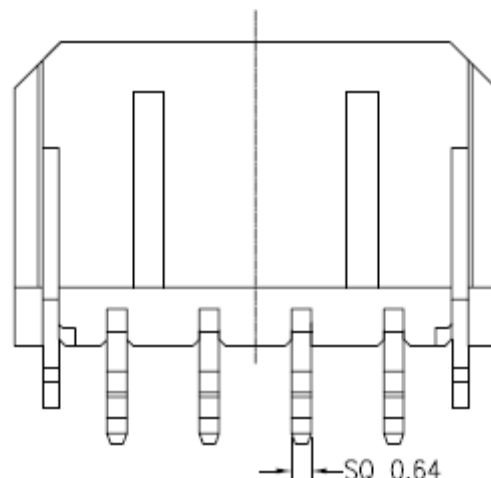


Specifications

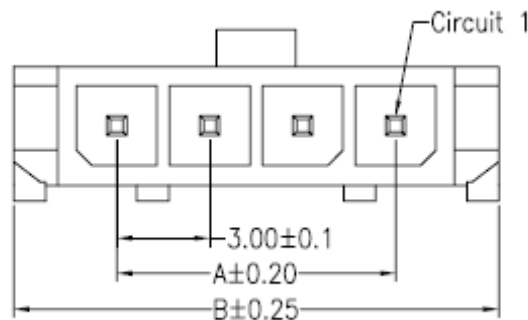
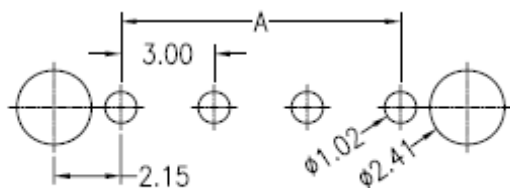
Voltage Rating: 250VAC/DC
 Current Rating: 5,0A
 Operating Temperature: -25°C ~ +85°C
 Contact Resistance: 10m Ohm max.
 Withstanding Voltage: 1500VAC/Minute
 Insulation Resistance: 1000M Ohm min.

Contact Material: Brass
 Contact Plating: AU or Sn over Ni.
 Insulator Material: High Temperature Plastic UL94V-0

Drawing (dimensions all into mm)



Terminal Assembly Drawing



Wafer Serie T68Qxxx Pitch
3,00mm

Part No.: **T68Q015**

Customer:

DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	02.04.2009
APPD:	Schumi			FINISH	Jamy		Sheet No.	1 from 4	

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Dimension Informations about Wafer

Pos.	Dimension (mm)					
	A	B	C	D	E	F
2	3,00	9,65				
3	6,00	12,65				
4	9,00	15,54				
5	12,00	18,65				
6	15,00	21,65				
7	18,00	24,65				
8	21,00	27,65				
9	24,00	30,65				
10	27,00	33,65				
11	30,00	36,65				
12	33,00	39,65				

Pos.	Dimension (mm)					
	A	B	C	D	E	F

Wafer Serie T68Qxxx Pitch 3,00mm
Part No.: T68Q015
Customer:

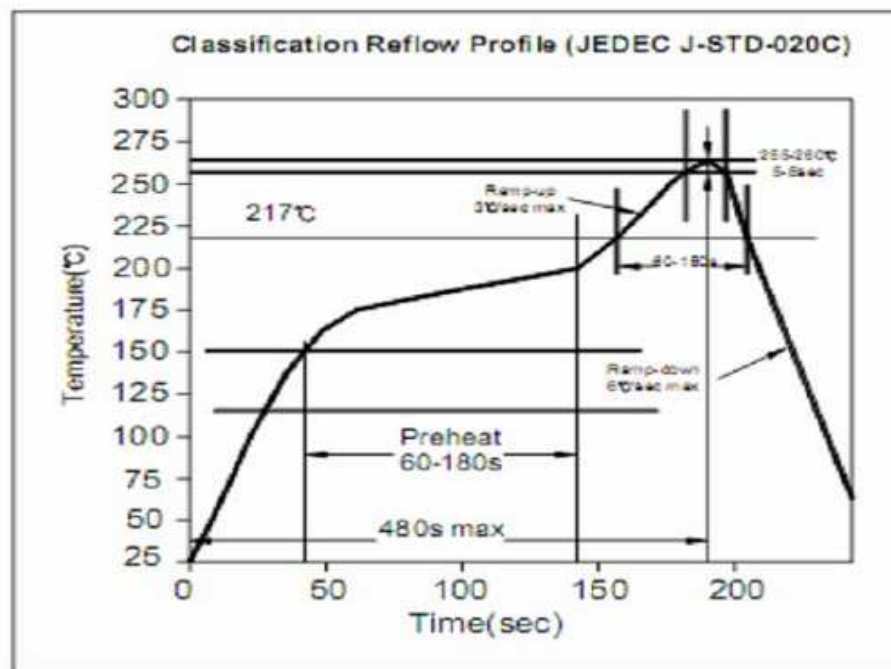
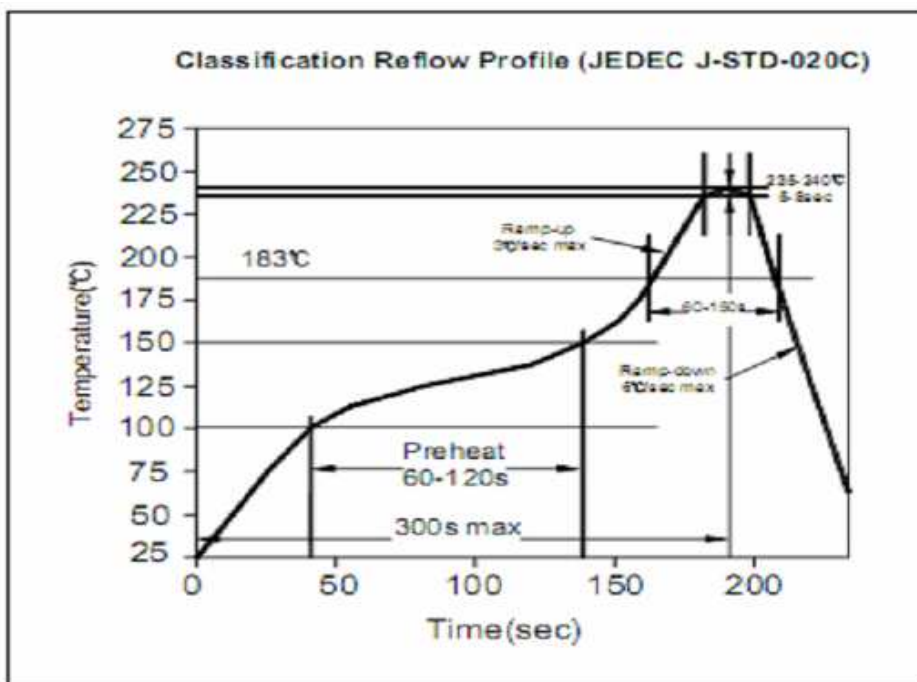
DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	02.04.2009
APPD:	Schumi			FINISH	Jamy		Sheet No.	2 from 4	



Soldering Profile

Lead Solder

Lead Free Solder



Wafer Serie T68Qxxx Pitch 3,00mm
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EDCON-COMPONENTS



Ordering Informations

Serie	Number of	Contact	Packing						
T68Q015	02	T	BU						

xx = Pos.	T= Tin Plated (Standard)	BU= Bulk (Standard)							
		TY= Tray Packing							
	G= Gold Flash Plated	TU= Tube Packing							

Wafer Serie T68Qxxx Pitch 3,00mm
Part No.: T68Q015
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